

SCOPE: This data sheet refers to silver-plated coated copper wire, produced by

- » electroplating of copper wire
- » drawing to final diameter

Properties (standard values)

SILVER PLATING	DENSITY
[%]	[g/cm³]
0.6	8.96
3.0	8.99
10.0	9.08

[»] electrical conductivity $\geq 56.0 \text{ m/}(\Omega \cdot \text{mm}^2)$

Composition

base metal Cu (core) CU-ETP – CW004 A acc. to EN 13602:2002 (E-Cu58 DIN 1757, DIN 1787)

Cu	≥	99.90 % (incl. max. 0.015 % Ag)
Bi	≤	0.0005 %
Pb	≤	0.005 %
Plated Ag	≥	99.97 %

TOTAL PLATED SILVER [wt%]	
0.6	
3.0	
10.0	

[»] adjusted according customers requirements